

Single N-channel MOSFET

ELM14468AA-N

■General description

ELM14468AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and low gate resistance.

■Features

- $V_{ds}=30V$
- $I_d=11.6A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 14m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 22m\Omega$ ($V_{gs}=4.5V$)

■Maximum absolute ratings

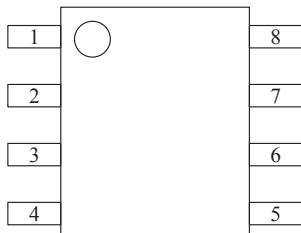
Parameter	Symbol	Limit	Unit	Note
Drain-source voltage	V_{ds}	30	V	
Gate-source voltage	V_{gs}	± 20	V	
Continuous drain current Ta=25°C	I_d	11.6	A	1
Ta=70°C		9.2		
Pulsed drain current	I_{dm}	50	A	2
Power dissipation Ta=25°C	P_d	3.1	W	
Ta=70°C		2.0		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	°C	

■Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R_{\theta ja}$	31	40	°C/W	1
Maximum junction-to-ambient	Steady-state		59	75	°C/W	
Maximum junction-to-lead	Steady-state	$R_{\theta jl}$	16	24	°C/W	3

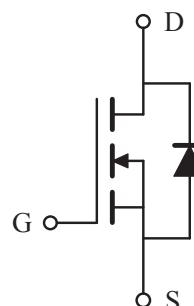
■Pin configuration

SOP-8(TOP VIEW)



Pin No.	Pin name
1	SOURCE
2	SOURCE
3	SOURCE
4	GATE
5	DRAIN
6	DRAIN
7	DRAIN
8	DRAIN

■Circuit



Single N-channel MOSFET

ELM14468AA-N

■Electrical characteristics

$T_a=25^\circ C$

Parameter	Symbol	Condition		Min.	Typ.	Max.	Unit
STATIC PARAMETERS							
Drain-source breakdown voltage	BV_{DSS}	$I_d=250\mu A, V_{GS}=0V$		30			V
Zero gate voltage drain current	Id_{SS}	$V_{DS}=24V$			0.003	1.000	μA
		$V_{GS}=0V$	$T_j=55^\circ C$			5.000	
Gate-body leakage current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$				± 100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_d=10mA$		1.5	2.0	3.0	V
On state drain current	$I_d(on)$	$V_{GS}=4.5V, V_{DS}=5V$		50			A
Static drain-source on-resistance	$R_{DS(on)}$	$V_{GS}=10V$			11.0	14.0	$m\Omega$
		$I_d=11.6A$	$T_j=125^\circ C$		17.0	21.0	
		$V_{GS}=4.5V, I_d=10A$			17.4	22.0	$m\Omega$
Forward transconductance	G_{FS}	$V_{DS}=5V, I_d=11.6A$			19		S
Diode forward voltage	V_{SD}	$I_S=1A, V_{GS}=0V$			0.73	1.00	V
Max. body-diode continuous current	I_S					4.5	A
DYNAMIC PARAMETERS							
Input capacitance	C_{iss}	$V_{GS}=0V, V_{DS}=15V, f=1MHz$			955	1200	pF
Output capacitance	C_{oss}				145		pF
Reverse transfer capacitance	C_{rss}				112		pF
Gate resistance	R_g	$V_{GS}=0V, V_{DS}=0V, f=1MHz$			0.50	0.85	Ω
SWITCHING PARAMETERS							
Total gate charge (10V)	Q_g	$V_{GS}=10V, V_{DS}=15V, I_d=11.6A$			17.0	24.0	nC
Total gate charge (4.5V)	Q_g				9.0	12.0	nC
Gate-source charge	Q_{gs}				3.4		nC
Gate-drain charge	Q_{gd}				4.7		nC
Turn-on delay time	$t_{d(on)}$	$V_{GS}=10V, V_{DS}=15V$ $R_L=1.3\Omega, R_{gen}=3\Omega$			5.0	6.5	ns
Turn-on rise time	t_r				6.0	7.5	ns
Turn-off delay time	$t_{d(off)}$				19.0	25.0	ns
Turn-off fall time	t_f				4.5	6.0	ns
Body diode reverse recovery time	t_{rr}	$I_F=11.6A, dI/dt=100A/\mu s$			19	21	ns
Body diode reverse recovery charge	Q_{rr}	$I_F=11.6A, dI/dt=100A/\mu s$			9	12	nC

NOTE :

1. The value of $R_{\theta ja}$ is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with $T_a=25^\circ C$. The value in any given applications depends on the user's specific board design. The current rating is based on the $t \leq 10s$ thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The $R_{\theta ja}$ is the sum of the thermal impedance from junction to lead $R_{\theta jl}$ and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80 μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_a=25^\circ C$. The SOA curve provides a single pulse rating.



Single N-channel MOSFET

ELM14468AA-N

■ Typical electrical and thermal characteristics

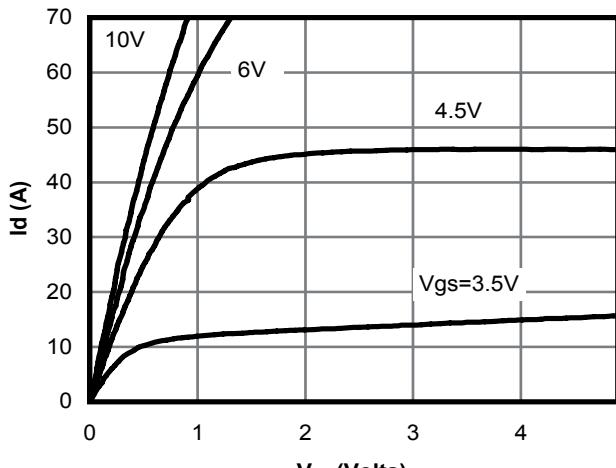


Fig 1: On-Region Characteristics

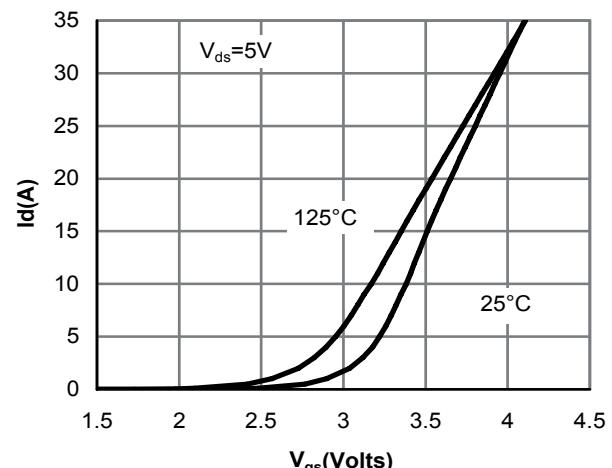


Figure 2: Transfer Characteristics

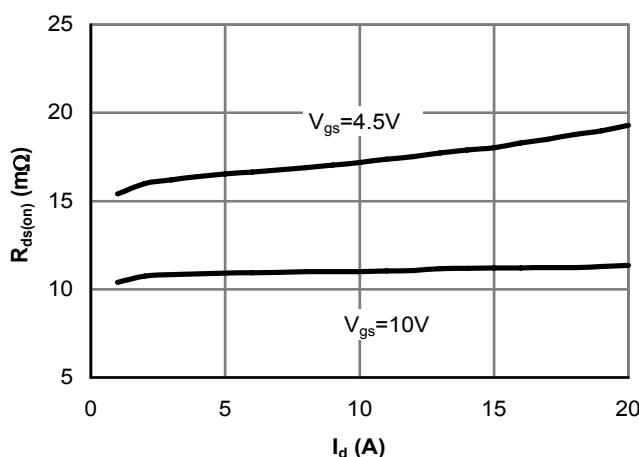


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

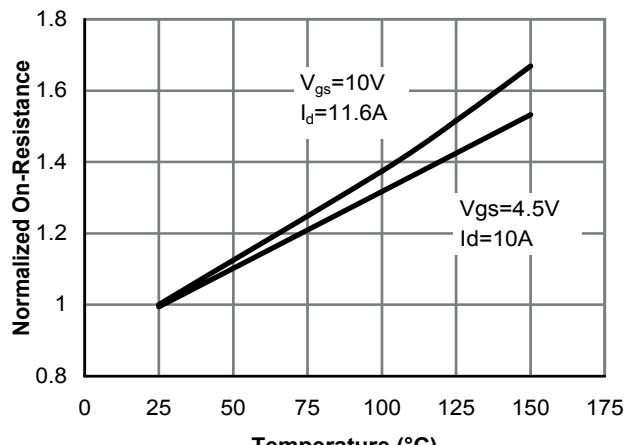


Figure 4: On-Resistance vs. Junction Temperature

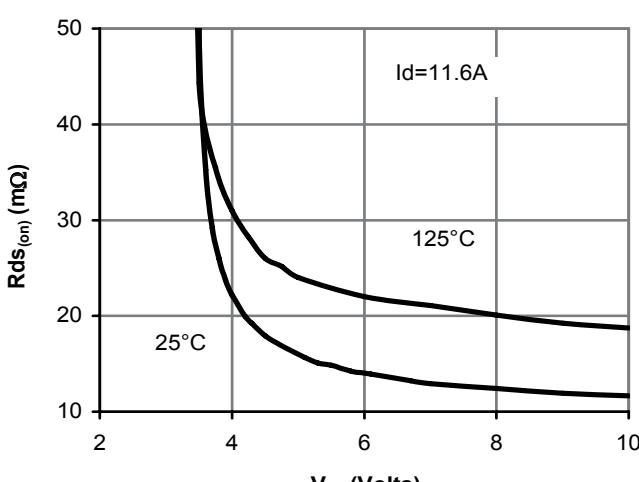


Figure 5: On-Resistance vs. Gate-Source Voltage

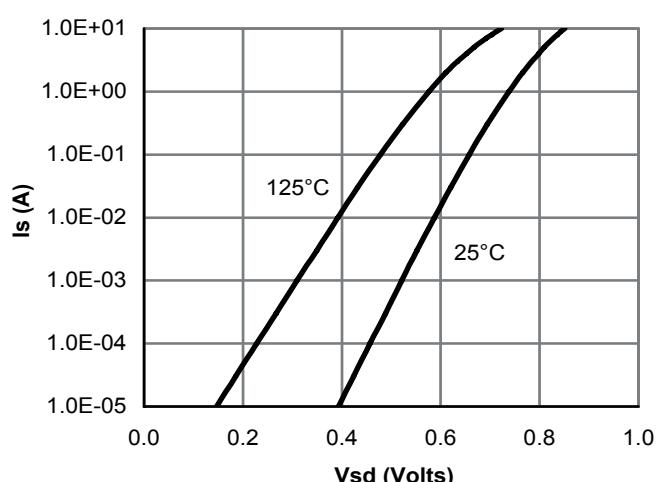


Figure 6: Body-Diode Characteristics

Single N-channel MOSFET

ELM14468AA-N

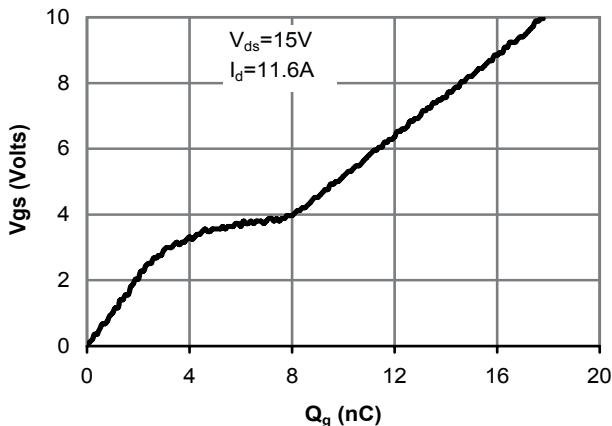


Figure 7: Gate-Charge Characteristics

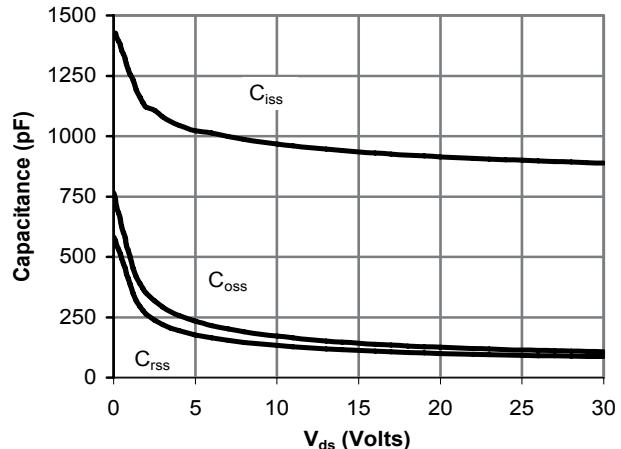


Figure 8: Capacitance Characteristics

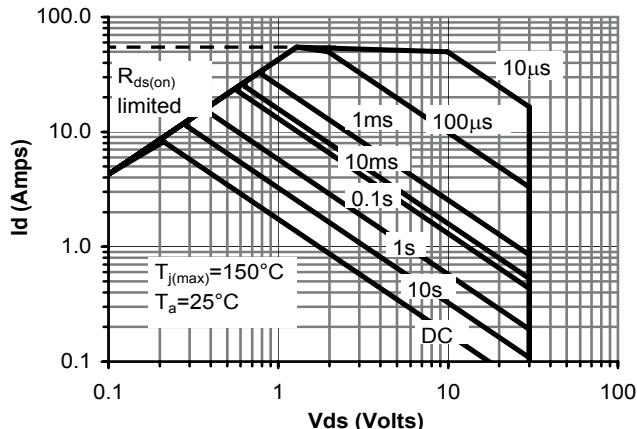


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

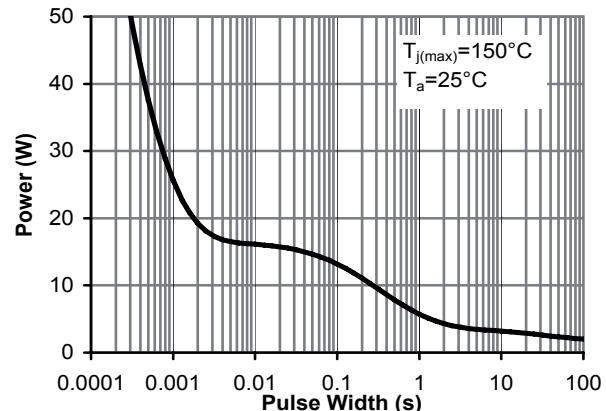


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

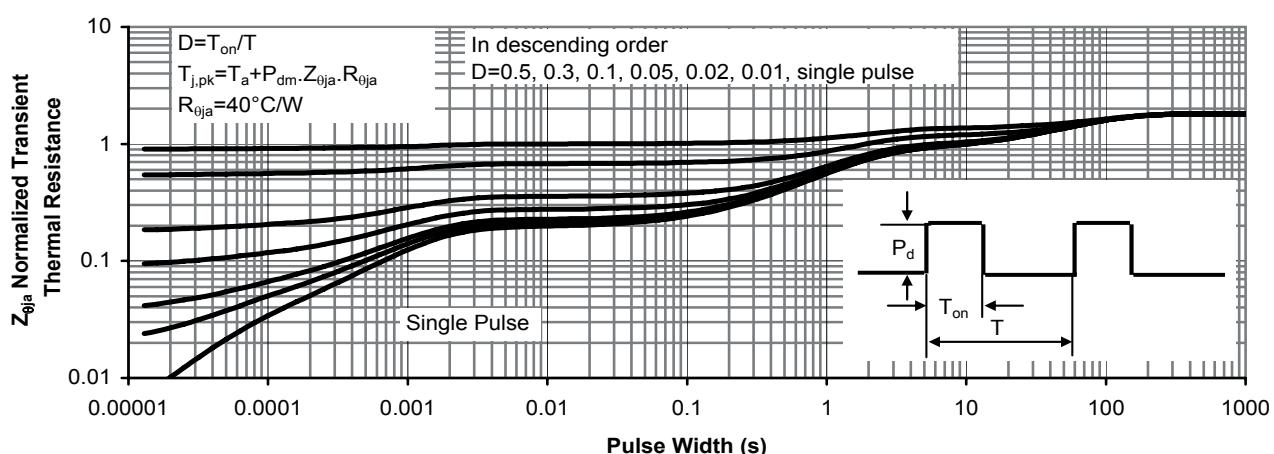


Figure 11: Normalized Maximum Transient Thermal Impedance